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Contact us

LTC5510

1MHz to 6GHz Wideband High Linearity Active Mixer

FEATURES

- **Input Frequency Range to 6GHz**
- **50Ω Matched Input from 30MHz to >3GHz**
- **Capable of Up- or Down-Conversion**
- **OIP3: 27dBm at f_{OUT} = 1575MHz**
- **1.5dB Conversion Gain**
- **Noise Figure: 11.6dB at f_{OUT} = 1575MHz**
- **High Input P1dB: 11dBm at 5V**
- **5V or 3.3V Supply at 105mA**
- Shutdown Control
- LO Input Impedance Always Matched
- 0dBm LO Drive Level
- On-Chip Temperature Monitor
- –40°C to 105°C Operation (T_C)
- 16-Lead (4mm × 4mm) QFN Package

APPLICATIONS

- Wideband Receivers/Transmitters
- Cable Downlink Infrastructure
- HF/VHF/UHF Mixer
- Wireless Infrastructure

DESCRIPTION

The LTC®5510 is a high linearity mixer optimized for applications requiring very wide input bandwidth, low distortion, and low LO leakage. The chip includes a double-balanced active mixer with an input buffer and a high speed LO amplifier. The input is optimized for use with 1:1 transmission-line baluns, allowing very wideband impedance matching. The mixer can be used for both up- and down-conversion and can be used in wideband systems.

The LO can be driven differentially or single-ended and requires only 0dBm of LO power to achieve excellent distortion and noise performance, while also reducing external drive circuit requirements. The LTC5510 offers low LO leakage, greatly reducing the need for output filtering to meet LO suppression requirements.

The LTC5510 is optimized for 5V but can also be used with a 3.3V supply with slightly reduced performance. The shutdown function allows the part to be disabled for further power savings.
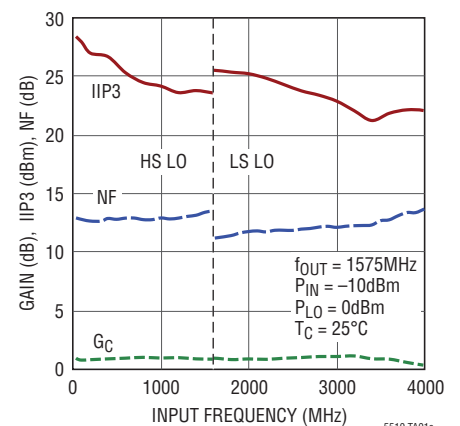
TYPICAL APPLICATION

30MHz to 4GHz Up/Down Mixer for Wideband Receiver
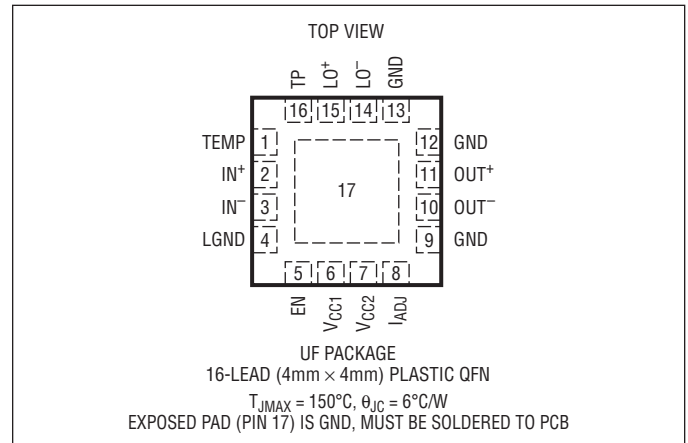

Conversion Gain, IIP3 and NF vs Input Frequency

5510fa

LTC5510
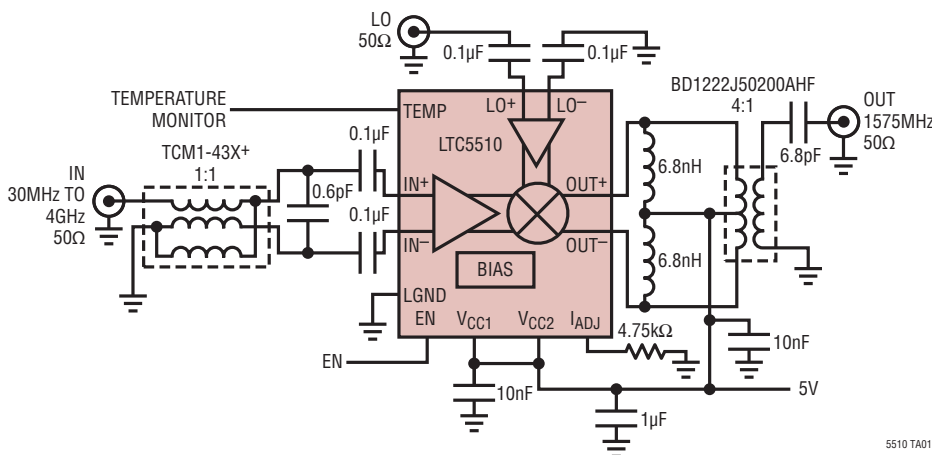
ABSOLUTE MAXIMUM RATINGS

(Note 1)

Supply Voltage (V_{CC1}, V_{CC2}, OUT$^+$, OUT$^-$)...............6.0V
Enable Voltage (EN) ....-0.3V to V_{CC} + 0.3V
Current Adjust Voltage (I_{ADJ}) ....-0.3V to 2.7V
LO Input Power (1MHz to 6GHz) ....+10dBm
LO Differential DC Voltage 1.5V
LO$^+$, LO$^-$ Input DC Voltage..........................-0.3V to 3V
IN$^+$, IN$^-$ Input Power (1MHz to 6GHz) ....+15dBm
IN$^+$, IN$^-$ Input DC Voltage ....-0.3V to 2.4V
Temp Monitor Input Current (TEMP).....................10mA
Operating Temperature Range (T_C)........-40°C to 105°C
Storage Temperature Range ....-65°C to 150°C
Junction Temperature (T_J) .... 150°C

PIN CONFIGURATION

TOP VIEW

TP | LO$^+$ | LO$^-$ | GND

| 16 | 15 | 14 | 13 |

TEMP [1] .... [12] GND
IN$^+$ [2] .... [11] OUT$^+$
IN$^-$ [3] .. 17 .. [10] OUT$^-$
LGND [4] .... [9] GND

| 5 | 6 | 7 | 8 |

EN | V_{CC1} | V_{CC2} | I_{ADJ}

UF PACKAGE
16-LEAD (4mm × 4mm) PLASTIC QFN
T_{JMAX} = 150°C, θ_{JC} = 6°C/W
EXPOSED PAD (PIN 17) IS GND, MUST BE SOLDERED TO PCB

ORDER INFORMATION

AC ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_C = 25°C. EN = High, P_{LO} = 0dBm. Test circuit shown in Figure 1. (Notes 2, 3, 4)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Input Frequency Range	Requires External Matching	●		1 to 6000		MHz
LO Input Frequency Range		●		1 to 6500		MHz
Output Frequency Range	Requires External Matching	●		1 to 6000		MHz
Input Return Loss	Z_O = 50Ω, 30MHz to 3GHz			>11		dB
LO Input Return Loss	Z_O = 50Ω, 1MHz to 5GHz			>10		dB
Output Impedance	Differential at 1500MHz			201Ω||0.6pF		R||C
LO Input Power	f_{LO} = 1MHz to 5GHz		-6	0	6	dBm
5V Wideband Up/Downmixer Application: f_{IN} = 30MHz to 3000MHz, f_{OUT} = 1575MHz, V_{CC} = 5V, R1 = 4.75kΩ						
Conversion Gain	f_{IN} = 190MHz, f_{LO} = 1765MHz, Upmixer		0.5	1.5		dB
	f_{IN} = 900MHz, f_{LO} = 2475MHz, Upmixer			1.4		dB
	f_{IN} = 2150MHz, f_{LO} = 575MHz, Downmixer			1.1		dB
	f_{IN} = 2600MHz, f_{LO} = 1025MHz, Downmixer			1.2		dB
Conversion Gain vs Temperature	T_C = -40°C to 105°C, f_{IN} = 900MHz	●		-0.007		dB/°C

AC ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_C = 25°C. EN = High, P_{LO} = 0dBm, P_{IN} = −10dBm (−10dBm/tone for two-tone tests), unless otherwise noted. Test circuit shown in Figure 1. (Notes 2, 3, 4)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Two-Tone Output 3rd Order Intercept (Δf = 2MHz)	f_{IN} = 190MHz, f_{LO} = 1765MHz, Upmixer		24.0	27.8		dBm
	f_{IN} = 900MHz, f_{LO} = 2475MHz, Upmixer			25.0		dBm
	f_{IN} = 2150MHz, f_{LO} = 575MHz, Downmixer			26.0		dBm
	f_{IN} = 2600MHz, f_{LO} = 1025MHz, Downmixer			24.5		dBm
SSB Noise Figure	f_{IN} = 190MHz, f_{LO} = 1765MHz, Upmixer			11.6	14.5	dB
	f_{IN} = 900MHz, f_{LO} = 2475MHz, Upmixer			12.1		dB
	f_{IN} = 2150MHz, f_{LO} = 575MHz, Downmixer			11.6		dB
	f_{IN} = 2600MHz, f_{LO} = 1025MHz, Downmixer			11.8		dB
SSB Noise Figure Under Blocking	f_{IN} =900MHz, f_{LO} = 2475MHz, f_{BLOCK} = 800MHz, P_{BLOCK} = +5dBm			20.3		dB
LO-IN Leakage	f_{LO} = 20MHz to 3300MHz			<−50		dBm
LO-OUT Leakage	f_{LO} = 20MHz to 1000MHz			<−40		dBm
	f_{LO} = 1000MHz to 3300MHz			<−33		dBm
IN-OUT Isolation	f_{IN} = 20MHz to 1150MHz			>40		dB
	f_{IN} = 1150MHz to 3000MHz			>22		dB
IN-LO Isolation	f_{IN} = 30MHz to 3000MHz			>55		dB
Input 1dB Compression	f_{IN} = 190MHz, f_{LO} = 1765MHz, Upmixer			11.0		dBm
	f_{IN} = 900MHz, f_{LO} = 2475MHz, Upmixer			12.2		dBm
	f_{IN} = 2150MHz, f_{LO} = 575MHz, Downmixer			11.5		dBm
	f_{IN} = 2600MHz, f_{LO} = 1025MHz, Downmixer			11.6		dBm
3.3V Wideband Up/Downmixer Application: f_{IN} = 30MHz to 3000MHz, f_{OUT} = 1575MHz, V_{CC} = 3.3V, R1 = 1.8kΩ						
Conversion Gain	f_{IN} = 190MHz, f_{LO} = 1765MHz, Upmixer			1.5		dB
	f_{IN} = 900MHz, f_{LO} = 2475MHz, Upmixer			1.4		dB
	f_{IN} = 2150MHz, f_{LO} = 575MHz, Downmixer			1.1		dB
	f_{IN} = 2600MHz, f_{LO} = 1025MHz, Downmixer			1.2		dB
Conversion Gain vs Temperature	T_C = −40°C to 105°C, f_{IN} = 900MHz	●		−0.006		dB/°C
Two-Tone Output 3rd Order Intercept (Δf = 2MHz)	f_{IN} = 190MHz, f_{LO} = 1765MHz, Upmixer			24.2		dBm
	f_{IN} = 900MHz, f_{LO} = 2475MHz, Upmixer			23.3		dBm
	f_{IN} = 2150MHz, f_{LO} = 575MHz, Downmixer			23.9		dBm
	f_{IN} = 2600MHz, f_{LO} = 1025MHz, Downmixer			22.3		dBm
SSB Noise Figure	f_{IN} = 190MHz, f_{LO} = 1765MHz, Upmixer			11.2		dB
	f_{IN} = 900MHz, f_{LO} = 2475MHz, Upmixer			12.2		dB
	f_{IN} = 2150MHz, f_{LO} = 575MHz, Downmixer			11.4		dB
	f_{IN} = 2600MHz, f_{LO} = 1025MHz, Downmixer			11.4		dB
SSB Noise Figure Under Blocking	f_{IN} = 900MHz, f_{LO} = 2475MHz, f_{BLOCK} = 800MHz P_{BLOCK} = +5dBm			20.8		dB
LO-IN Leakage	f_{LO} = 20MHz to 3300MHz			<−50		dBm
LO-OUT Leakage	f_{LO} = 20MHz to 1000MHz			<−40		dBm
	f_{LO} = 1000MHz to 3300MHz			<−33		dBm
IN-OUT Isolation	f_{IN} = 20MHz to 1150MHz			>40		dB
	f_{IN} = 1150MHz to 3000MHz			>22		dB
IN-LO Isolation	f_{IN} = 30MHz to 3000MHz			>55		dB
Input 1dB Compression	f_{IN} = 190MHz, f_{LO} = 1765MHz, Upmixer			8.9		dBm
	f_{IN} = 900MHz, f_{LO} = 2475MHz, Upmixer			10.7		dBm
	f_{IN} = 2150MHz, f_{LO} = 575MHz, Downmixer			10.1		dBm
	f_{IN} = 2600MHz, f_{LO} = 1025MHz, Downmixer			9.6		dBm

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AC ELECTRICAL CHARACTERISTICS
The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_C = 25°C. EN = High, P_{LO} = 0dBm, P_{IN} = −10dBm (−10dBm/tone for two-tone tests), unless otherwise noted. Test circuit shown in Figure 1. (Notes 2, 3, 4)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
5V Wideband Upmixer Application: f_{IN} = 30MHz to 1000MHz, f_{OUT} = 2140MHz, $f_{LO} = f_{IN} + f_{OUT}$, V_{CC} = 5V, R1 = 4.75kΩ						
Conversion Gain	f_{IN} = 190MHz			1.1		dB
	f_{IN} = 450MHz			1.0		dB
	f_{IN} = 900MHz			1.0		dB
Conversion Gain vs Temperature	T_C = −40°C to 105°C, f_{IN} = 190MHz	●		−0.006		dB/°C
Two-Tone Output 3rd Order Intercept	f_{IN} = 190MHz			25.6		dBm
(Δf = 2MHz)	f_{IN} = 450MHz			24.6		dBm
	f_{IN} = 900MHz			23.9		dBm
SSB Noise Figure	f_{IN} = 190MHz			12.0		dB
	f_{IN} = 450MHz			12.2		dB
	f_{IN} = 900MHz			12.4		dB
SSB Noise Floor at P_{IN} = +5dBm	f_{IN} = 800MHz, f_{LO} = 3040MHz, f_{OUT} = 2140MHz			−151.4		dBm/Hz
LO-IN Leakage	f_{LO} = 2100MHz to 3500MHz			<−50		dBm
LO-OUT Leakage	f_{LO} = 2100MHz to 3500MHz			<−31		dBm
IN-OUT Isolation	f_{IN} = 30MHz to 1100MHz			>40		dB
IN-LO Isolation	f_{IN} = 30MHz to 1100MHz			>50		dB
Input 1dB Compression	f_{IN} = 190MHz			11.5		dBm
	f_{IN} = 450MHz			11.5		dBm
	f_{IN} = 900MHz			11.7		dBm
5V VHF/UHF Wideband Downmixer Application: f_{IN} = 100MHz to 1000MHz, f_{OUT} = 44MHz, $f_{LO} = f_{IN} + f_{OUT}$, V_{CC} = 5V, R1 = Open						
Conversion Gain	f_{IN} = 140MHz			1.9		dB
	f_{IN} = 456MHz			1.9		dB
	f_{IN} = 900MHz			1.9		dB
Conversion Gain vs Temperature	T_C = −40°C to 105°C, f_{IN} = 456MHz	●		−0.006		dB/°C
Two-Tone Input 3rd Order Intercept	f_{IN} = 140MHz			27.8		dBm
(Δf = 2MHz)	f_{IN} = 456MHz			28.5		dBm
	f_{IN} = 900MHz			26.8		dBm
SSB Noise Figure	f_{IN} = 140MHz			10.8		dB
	f_{IN} = 456MHz			10.9		dB
	f_{IN} = 900MHz			11.6		dB
SSB Noise Figure Under Blocking	f_{IN} = 900MHz, f_{LO} = 944MHz, f_{BLOCK} = 800MHz, P_{BLOCK} = +5dBm			20.0		dB
Two-Tone Input 2nd Order Intercept ($\Delta f = f_{IM2}$ = 42MHz)	f_{IN1} = 477MHz, f_{IN2} = 435MHz, f_{LO} = 500MHz			72		dBm
2LO-2RF Output Spurious Product ($f_{IN} = f_{LO} − f_{OUT}/2$)	f_{IN} = 478MHz at −6dBm, f_{LO} = 500MHz, f_{OUT} = 44MHz			−84		dBc
3LO-3RF Output Spurious Product ($f_{IN} = f_{LO} − f_{OUT}/3$)	f_{IN} = 485.33MHz at −6dBm, f_{LO} = 500MHz, f_{OUT} = 44.01MHz			−82		dBc
LO-IN Leakage	f_{LO} = 50MHz to 1200MHz			<−62		dBm
LO-OUT Leakage	f_{LO} = 50MHz to 1200MHz			<−31		dBm
IN-OUT Isolation	f_{IN} = 50MHz to 1000MHz			>23		dB
IN-LO Isolation	f_{IN} = 50MHz to 1000MHz			>62		dB
Input 1dB Compression	f_{IN} = 456MHz			12.1		dBm

AC ELECTRICAL CHARACTERISTICS
The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_C = 25°C. EN = High, P_{LO} = 0dBm, P_{IN} = −10dBm (−10dBm/tone for two-tone tests), unless otherwise noted. Test circuit shown in Figure 1. (Notes 2, 3, 4)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
5V VHF/UHF Upmixer Application: f_{IN} = 70MHz, f_{OUT} = 100MHz to 1000MHz, f_{LO} = f_{IN} + f_{OUT}, V_{CC} = 5V, R1 = Open, L3 = 220nH						
Conversion Gain	f_{OUT} = 456MHz			1.1		dB
Conversion Gain vs Temperature	T_C = −40°C to 105°C, f_{OUT} = 456MHz	●		−0.007		dB/°C
Two-Tone Output 3rd Order Intercept (Δf = 2MHz)	f_{OUT} = 456MHz			29.0		dBm
SSB Noise Figure	f_{OUT} = 456MHz			11.3		dB
SSB Noise Floor at P_{IN} = +5dBm	f_{IN} = 44MHz, f_{LO} = 532MHz, f_{OUT} = 462MHz			−152		dBm/Hz
LO-IN Leakage	f_{LO} = 100MHz to 1500MHz			<−62		dBm
LO-OUT Leakage	f_{LO} = 100MHz to 1500MHz			<−39		dBm
IN-OUT Isolation	f_{IN} = 50MHz to 400MHz			>43		dB
IN-LO Isolation	f_{IN} = 50MHz to 400MHz			>70		dB
Input 1dB Compression	f_{OUT} = 456MHz			11.0		dBm

DC ELECTRICAL CHARACTERISTICS
The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_C = 25°C. V_{CC} = 5V, EN = High, unless otherwise noted. Test circuit shown in Figure 1. (Note 2)

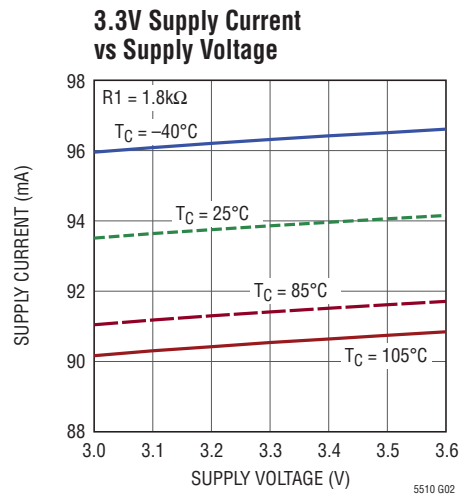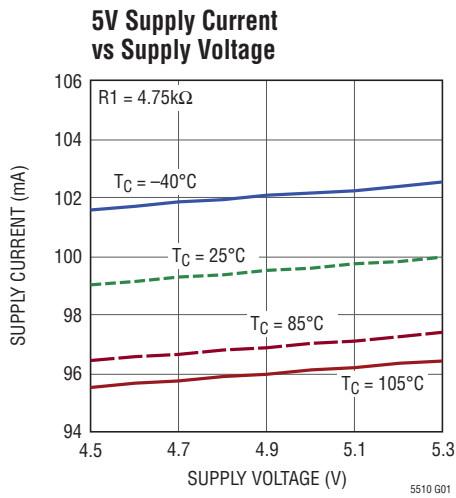| PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Power Supply						
Supply Voltage (Pins 6, 7, 10, 11)	5V Supply	●	4.5	5	5.3	V
	3.3V Supply	●	3.1	3.3	3.5	V
Supply Current (Pins 6, 7, 10, 11)	5V, R1 = Open			105		mA
	5V, R1 = 4.75k			99.6	113	mA
	3.3V, R1 = Open			105		mA
	3.3V, R1 = 1.8k			94		mA
Total Supply Current – Shutdown	EN = Low			1.3	2.5	mA
Enable Logic Input (EN)						
EN Input High Voltage (On)		●	1.8			V
EN Input Low Voltage (Off)		●			0.5	V
EN Input Current	−0.3V to V_{CC} + 0.3V		−20		200	μA
Turn-On Time	EN: Low to High			0.6		μs
Turn-Off Time	EN: High to Low			0.6		μs
Current Adjust Pin (I_{ADJ})						
Open Circuit DC Voltage				1.8		V
Short Circuit DC Current	I_{ADJ} Shorted to Ground			1.9		mA
Temperature Monitor Pin (TEMP)						
DC Voltage at T_J = 25°C	I_{IN} = 10μA			697		mV
	I_{IN} = 80μA			755		mV
Voltage Temperature Coefficient	I_{IN} = 10μA	●		−1.80		mV/°C
	I_{IN} = 80μA	●		−1.61		mV/°C

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The LTC5510 is guaranteed functional over the case operating temperature range of −40°C to 105°C. (θ_{JC} = 6°C/W)
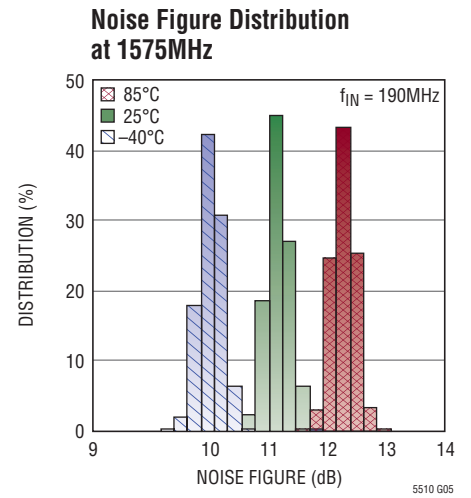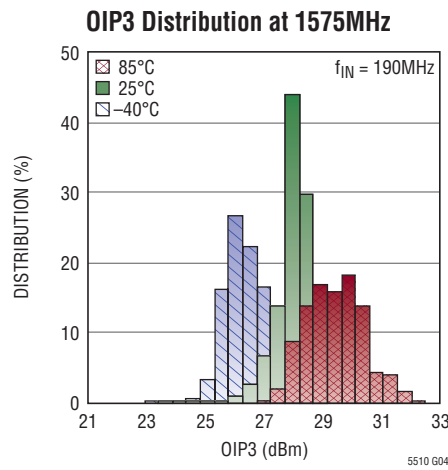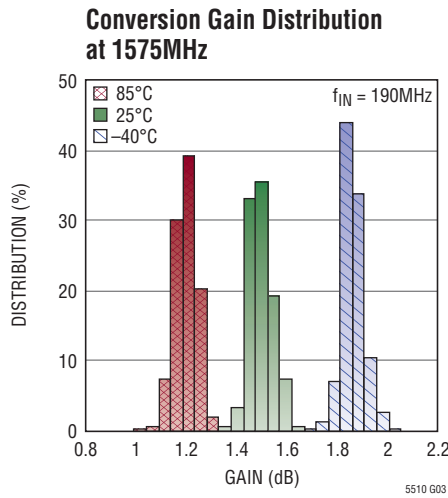
Note 3: SSB Noise Figure measured with a small-signal noise source, bandpass filter and 3dB matching pad on the signal input, bandpass filter and 6dB matching pad on the LO input, and no other RF signals applied.

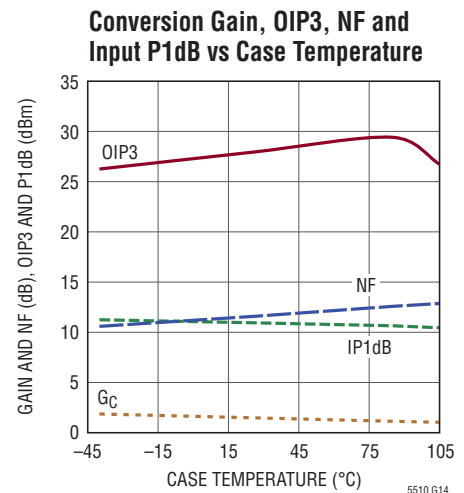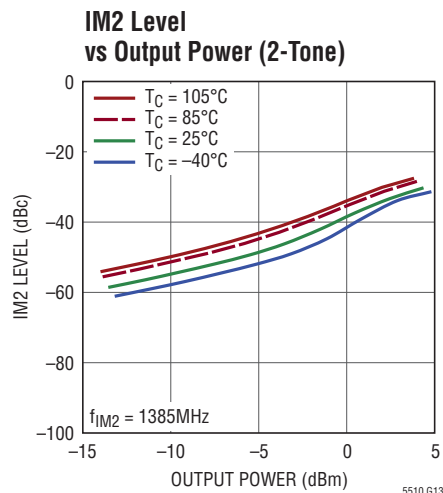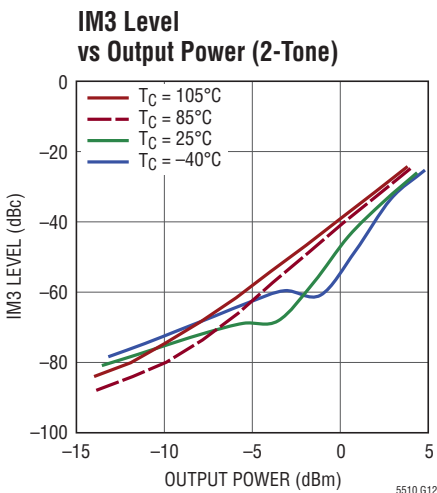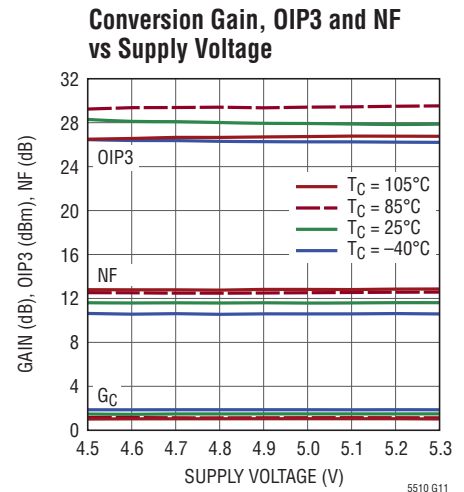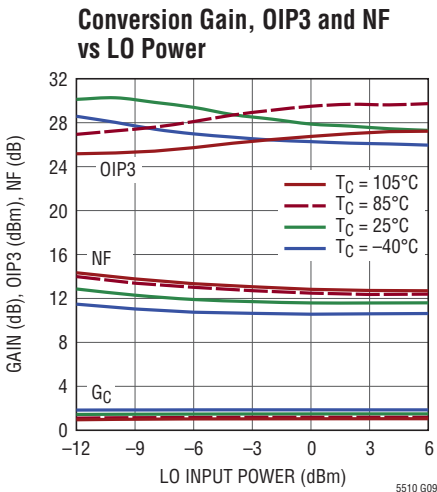**Note 4:** Specified performance includes all external component and evaluation PCB losses.

TYPICAL DC PERFORMANCE CHARACTERISTICS   (Test Circuit Shown in Figure 1)

5V Supply Current vs Supply Voltage

R1 = 4.75kΩ

$T_C = -40°C$
$T_C = 25°C$
$T_C = 85°C$
$T_C = 105°C$

SUPPLY CURRENT (mA)

SUPPLY VOLTAGE (V)

5510 G01

3.3V Supply Current vs Supply Voltage

R1 = 1.8kΩ

$T_C = -40°C$
$T_C = 25°C$
$T_C = 85°C$
$T_C = 105°C$

SUPPLY CURRENT (mA)

SUPPLY VOLTAGE (V)

5510 G02

TYPICAL AC PERFORMANCE CHARACTERISTICS 5V Wideband Up/Downmixer Application:

$V_{CC} = 5V$, $T_C = 25°C$, $f_{IN} = 190MHz$, $P_{IN} = -10dBm$ ($-10dBm/tone$ for 2-tone tests, $\Delta f = 2MHz$), $f_{LO} = 1765MHz$, $P_{LO} = 0dBm$, output measured at 1575MHz, unless otherwise noted. (Test Circuit Shown in Figure 1).
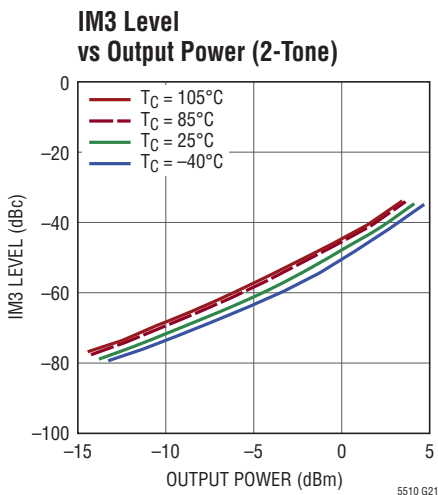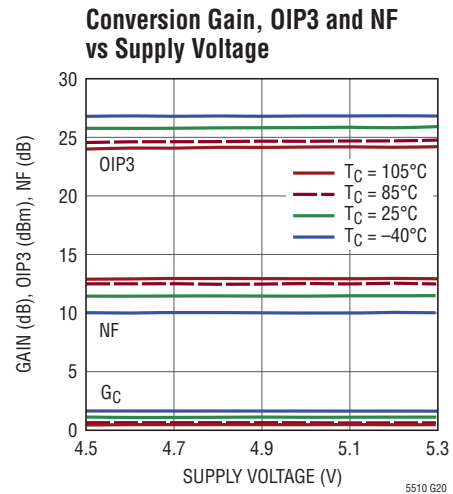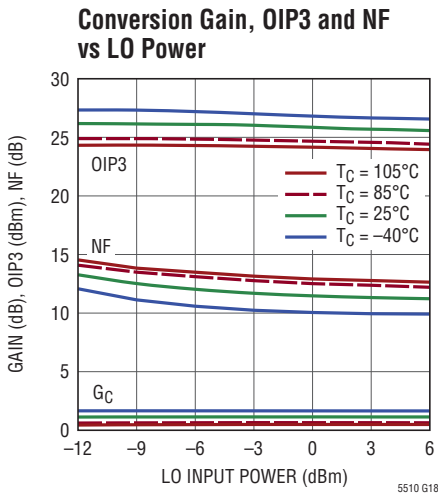
Conversion Gain Distribution at 1575MHz

85°C
25°C
−40°C

$f_{IN} = 190MHz$

DISTRIBUTION (%)

GAIN (dB)

5510 G03

OIP3 Distribution at 1575MHz

85°C
25°C
−40°C

$f_{IN} = 190MHz$

DISTRIBUTION (%)

OIP3 (dBm)

5510 G04

Noise Figure Distribution at 1575MHz

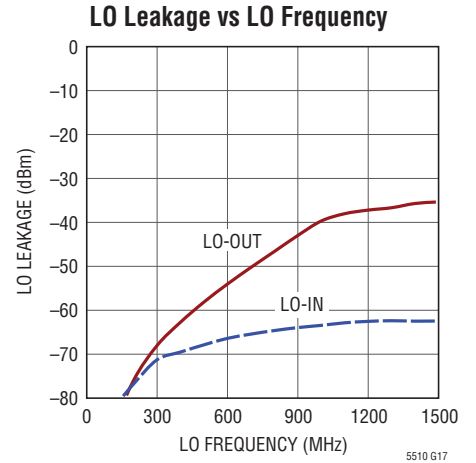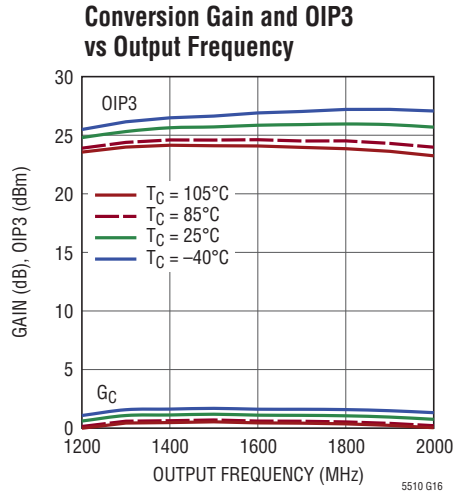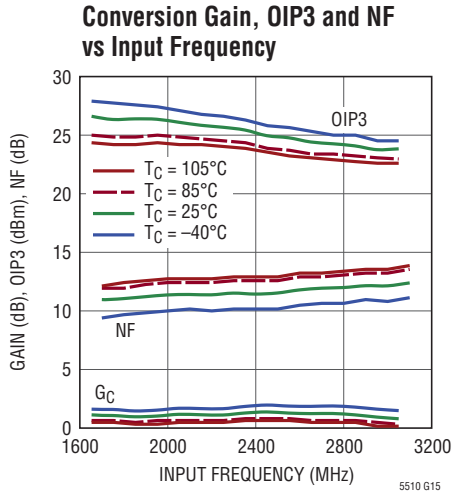85°C
25°C
−40°C

$f_{IN} = 190MHz$

DISTRIBUTION (%)

NOISE FIGURE (dB)

5510 G05

5510fa

TYPICAL AC PERFORMANCE CHARACTERISTICS

5V Wideband Up/Downmixer Application for f_IN < 1575MHz: V_CC = 5V, T_C = 25°C, f_IN = 190MHz, P_IN = −10dBm (−10dBm/tone for 2-tone tests, Δf = 2MHz), HSLO, P_LO = 0dBm, output measured at 1575MHz, unless otherwise noted. (Test Circuit Shown in Figure 1).

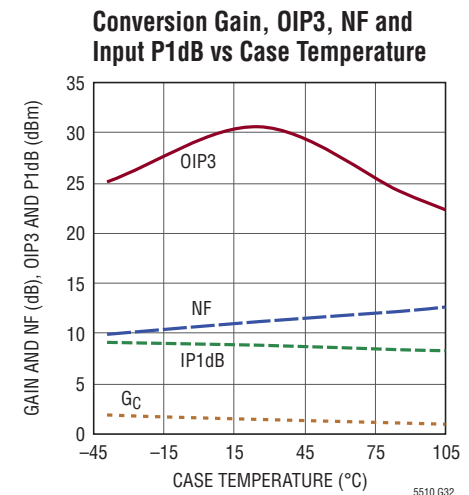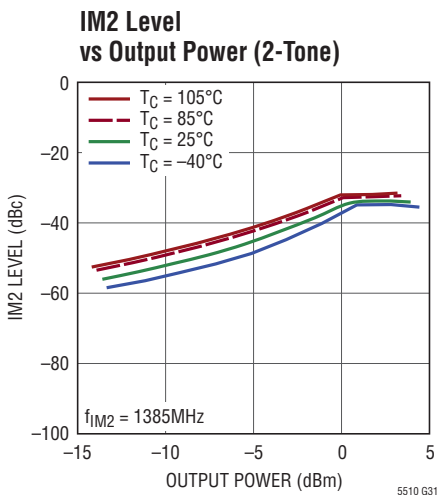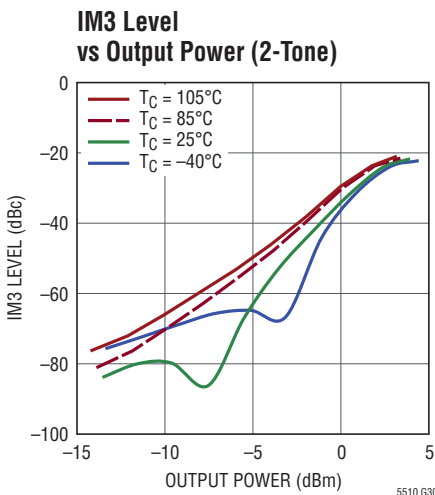### Conversion Gain, OIP3 and NF vs Input Frequency

5510 G06

Conversion Gain and OIP3 vs Output Frequency

5510 G07

LO Leakage vs LO Frequency

5510 G08

Conversion Gain, OIP3 and NF vs LO Power

5510 G09

Noise Figure vs Input Blocker Level

5510 G10

Conversion Gain, OIP3 and NF vs Supply Voltage

5510 G11

IM3 Level vs Output Power (2-Tone)

5510 G12

IM2 Level vs Output Power (2-Tone)

5510 G13

Conversion Gain, OIP3, NF and Input P1dB vs Case Temperature

5510 G14

5510fa

LTC5510
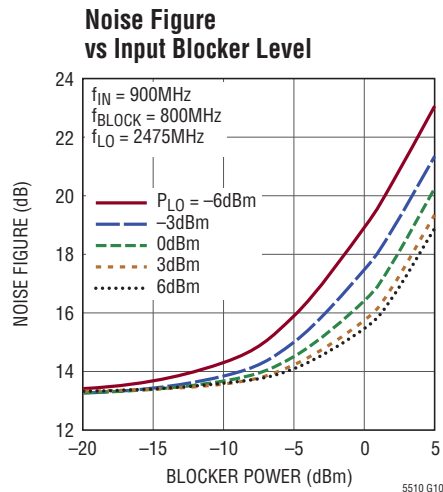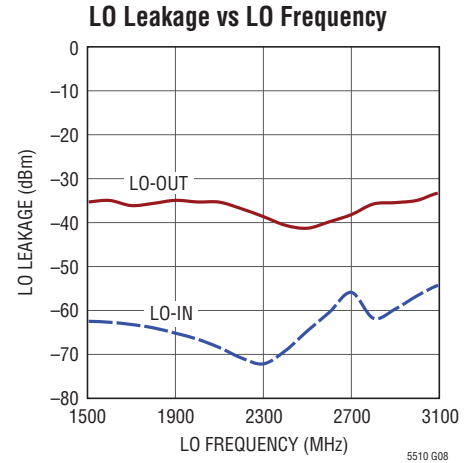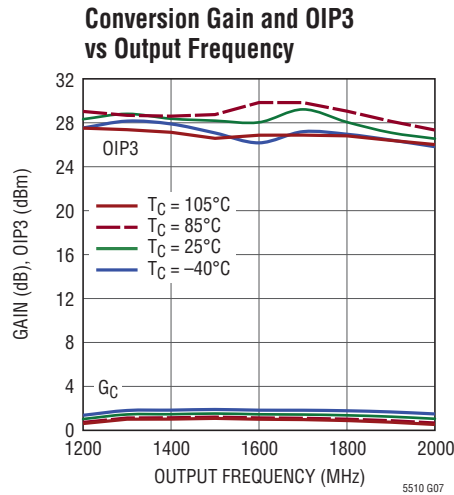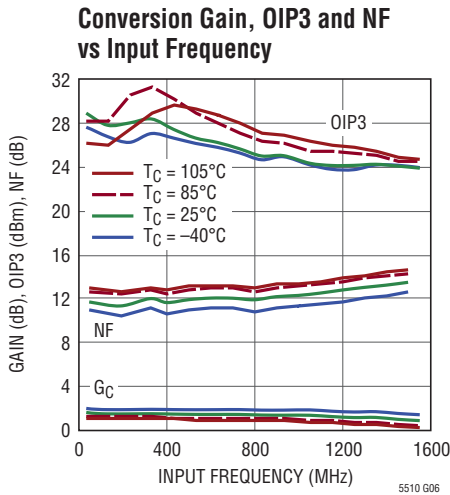
TYPICAL AC PERFORMANCE CHARACTERISTICS 5V Wideband Up/Downmixer Application

for f_{IN} > 1575MHz: V_{CC} = 5V, T_C = 25°C, f_{IN} = 2150MHz, P_{IN} = −10dBm (−10dBm/tone for 2-tone tests, Δf = 2MHz), LSLO, P_{LO} = 0dBm, output measured at 1575MHz, unless otherwise noted. (Test Circuit Shown in Figure 1).
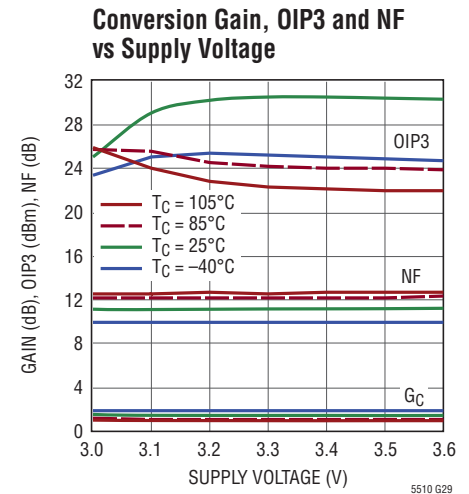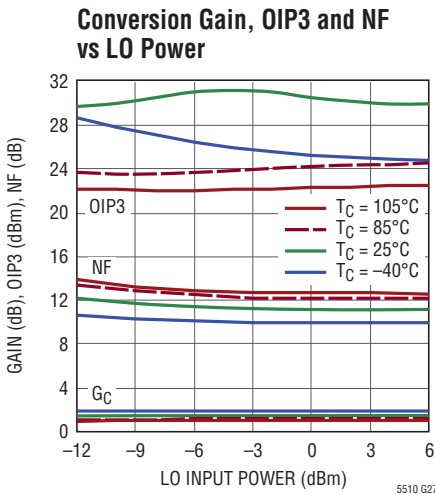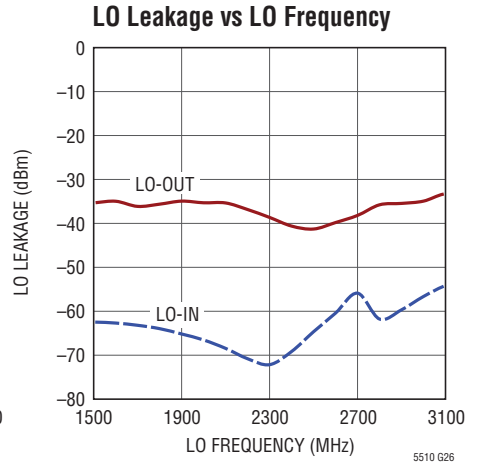
Conversion Gain, OIP3 and NF vs Input Frequency

5510 G15

Conversion Gain and OIP3 vs Output Frequency

5510 G16

LO Leakage vs LO Frequency

5510 G17

Conversion Gain, OIP3 and NF vs LO Power

5510 G18

Conversion Gain, OIP3 and NF vs Supply Voltage

5510 G20

IM3 Level vs Output Power (2-Tone)

5510 G21

Conversion Gain, OIP3, NF and Input P1dB vs Case Temperature

5510 G23
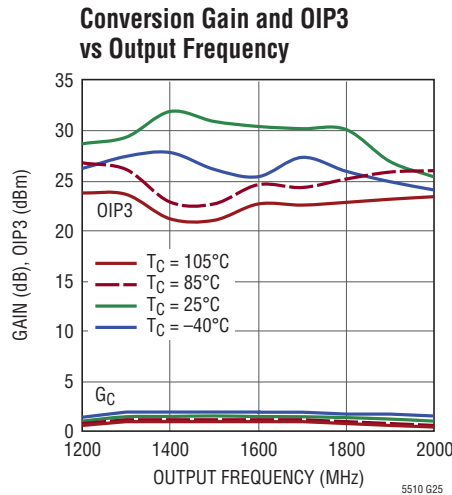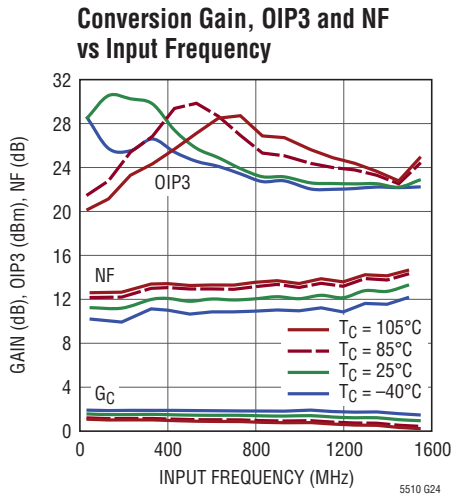
5510fa

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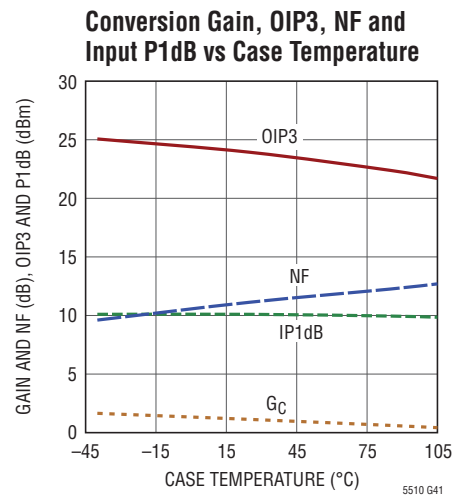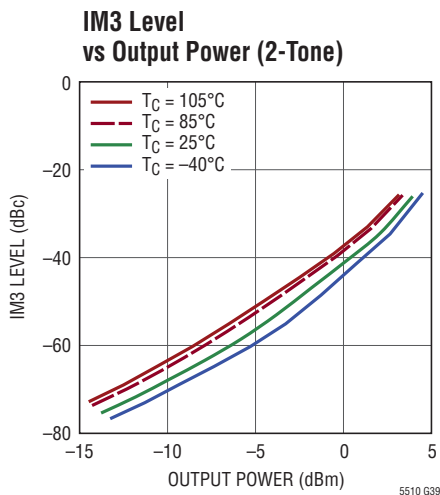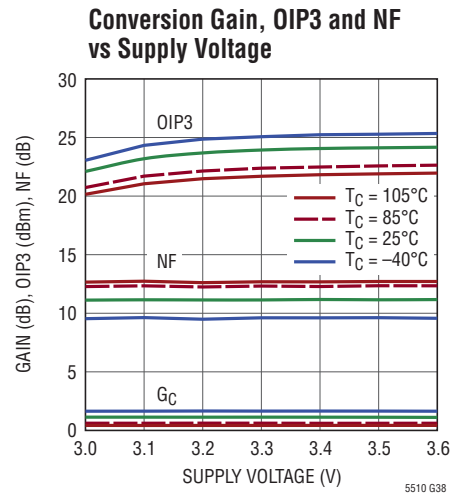# TYPICAL AC PERFORMANCE CHARACTERISTICS 3.3V Wideband Up/Downmixer Application

for f_{IN} < 1575MHz: V_{CC} = 3.3V, T_C = 25°C, f_{IN} = 190MHz, P_{IN} = –10dBm (–10dBm/tone for 2-tone tests, Δf = 2MHz), HSLO, P_{LO} = 0dBm, output measured at 1575MHz, unless otherwise noted. (Test Circuit Shown in Figure 1).

Conversion Gain, OIP3 and NF vs Input Frequency

5510 G24

Conversion Gain and OIP3 vs Output Frequency

5510 G25

LO Leakage vs LO Frequency

5510 G26

Conversion Gain, OIP3 and NF vs LO Power

5510 G27

Noise Figure vs Input Blocker Level

5510 G28

Conversion Gain, OIP3 and NF vs Supply Voltage

5510 G29

IM3 Level vs Output Power (2-Tone)

5510 G30

IM2 Level vs Output Power (2-Tone)

5510 G31

Conversion Gain, OIP3, NF and Input P1dB vs Case Temperature

5510 G32

5510fa
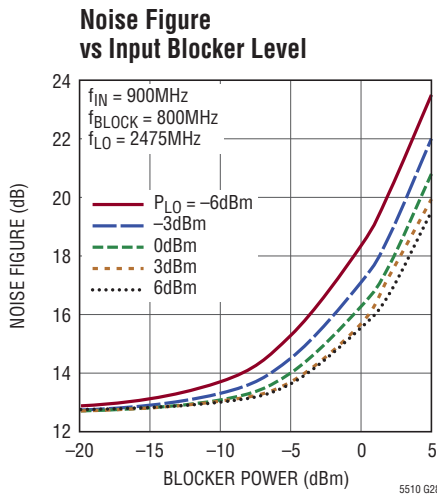
TYPICAL AC PERFORMANCE CHARACTERISTICS
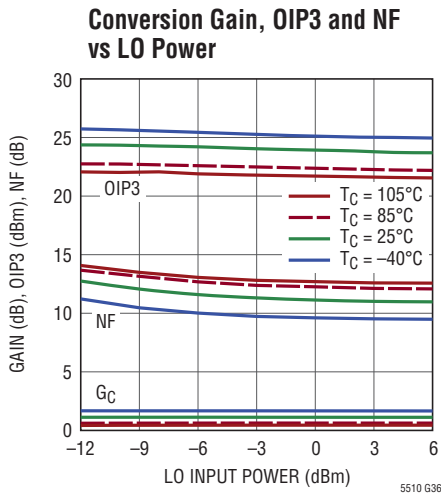
3.3V Wideband Up/Downmixer Application for $f_{IN} > 1575MHz$: $V_{CC} = 3.3V$, $T_C = 25°C$, $f_{IN} = 2150MHz$, $P_{IN} = -10dBm$ ($-10dBm$/tone for 2-tone tests, $\Delta f = 2MHz$), LSLO, $P_{LO} = 0dBm$, output measured at 1575MHz, unless otherwise noted. (Test Circuit Shown in Figure 1).

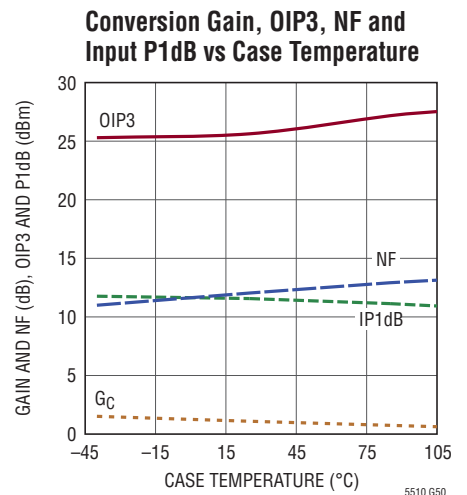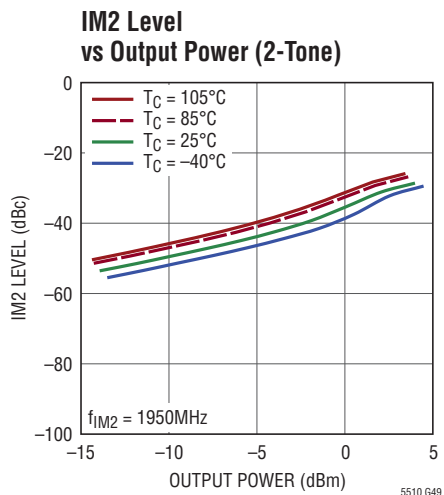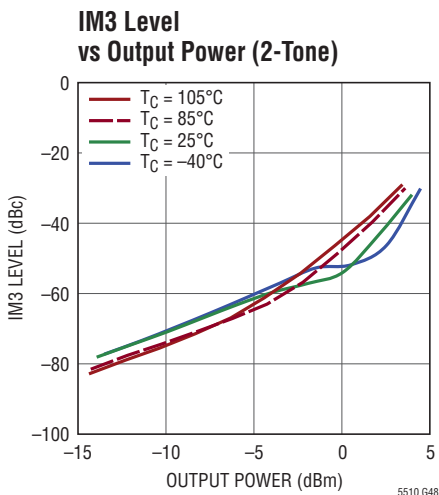**Conversion Gain, OIP3 and NF vs Input Frequency**

5510 G33

Conversion Gain and OIP3 vs Output Frequency

5510 G34

LO Leakage vs LO Frequency

5510 G35

Conversion Gain, OIP3 and NF vs LO Power

5510 G36

Conversion Gain, OIP3 and NF vs Supply Voltage

5510 G38

IM3 Level vs Output Power (2-Tone)

5510 G39

Conversion Gain, OIP3, NF and Input P1dB vs Case Temperature

5510 G41

5510fa
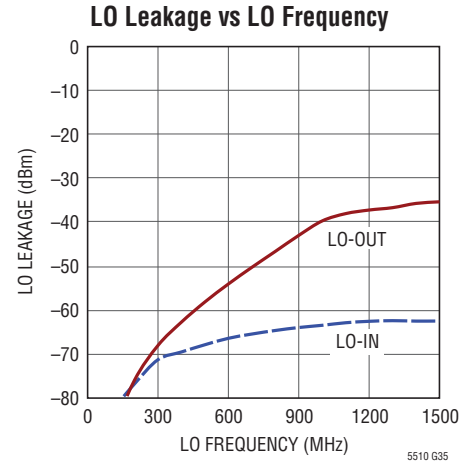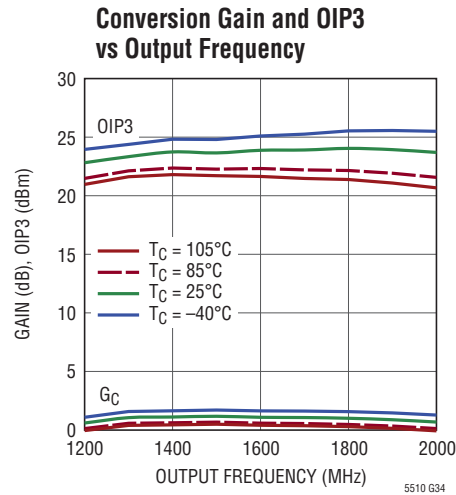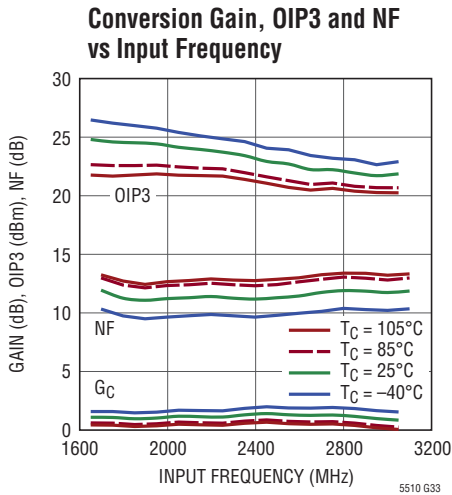
TYPICAL AC PERFORMANCE CHARACTERISTICS 5V Wideband Upmixer Application:

V_{CC} = 5V, T_C = 25°C, f_{IN} = 190MHz, P_{IN} = −10dBm (−10dBm/tone for 2-tone tests, Δf = 2MHz), HSLO, P_{LO} = 0dBm, output measured at 2140MHz, unless otherwise noted. (Test Circuit Shown in Figure 1).
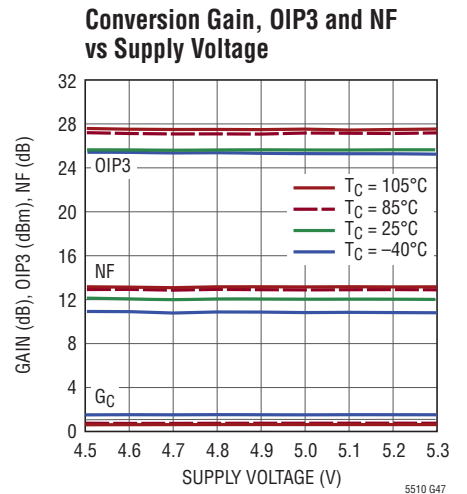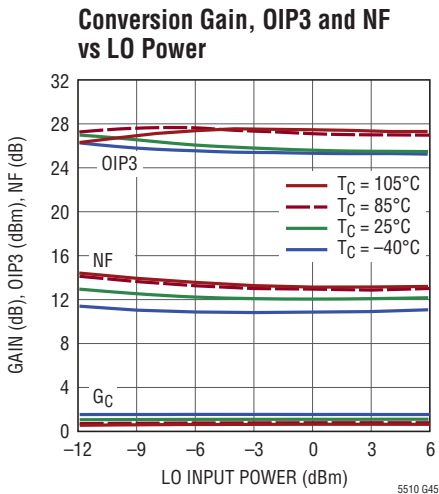
Conversion Gain, OIP3 and NF vs Input Frequency

5510 G42

Conversion Gain, OIP3 and NF vs Output Frequency

5510 G43

LO Leakage vs LO Frequency

5510 G44

Conversion Gain, OIP3 and NF vs LO Power

5510 G45

Output Noise Floor vs Input Power

5510 G46

Conversion Gain, OIP3 and NF vs Supply Voltage

5510 G47

IM3 Level vs Output Power (2-Tone)

5510 G48

IM2 Level vs Output Power (2-Tone)

5510 G49

Conversion Gain, OIP3, NF and Input P1dB vs Case Temperature

5510 G50

LTC5510

TYPICAL AC PERFORMANCE CHARACTERISTICS 5V VHF/UHF Upmixer Application:

V_{CC} = 5V, T_C = 25°C, f_{IN} = 70MHz, P_{IN} = −10dBm (−10dBm/tone for 2-tone tests, Δf = 2MHz), HSLO, P_{LO} = 0dBm, output measured at 456MHz, unless otherwise noted. (Test Circuit Shown in Figure 2).

Conversion Gain, OIP3 and NF vs Output Frequency

5510 G51

Conversion Gain and OIP3 vs Input Frequency

5510 G52

LO Leakage vs LO Frequency

5510 G53

Conversion Gain, OIP3 and NF vs LO Power

5510 G54

Output Noise Floor vs Input Power

f_{IN} = 44MHz
f_{OUT} = 462MHz
f_{LO} = 532MHz

5510 G55

Conversion Gain, OIP3 and NF vs Supply Voltage

5510 G56

IM3 Level vs Output Power (2-Tone)

5510 G57

IM2 Level vs Output Power (2-Tone)

f_{IM2} = 386MHz

5510 G58

Conversion Gain, OIP3, NF and Input P1dB vs Case Temperature

5510 G59

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TYPICAL AC PERFORMANCE CHARACTERISTICS

5V VHF/UHF Downmixer Application:

V_{CC} = 5V, T_C = 25°C, f_{IN} = 456MHz, P_{IN} = −10dBm (−10dBm/tone for 2-tone tests, Δf = 2MHz), HSLO, P_{LO} = 0dBm, output measured at 44MHz, unless otherwise noted. (Test Circuit Shown in Figure 2).
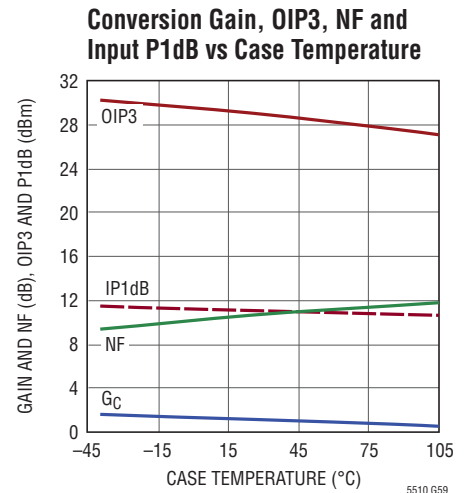
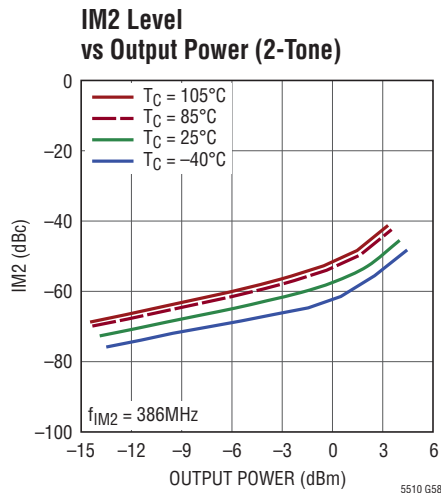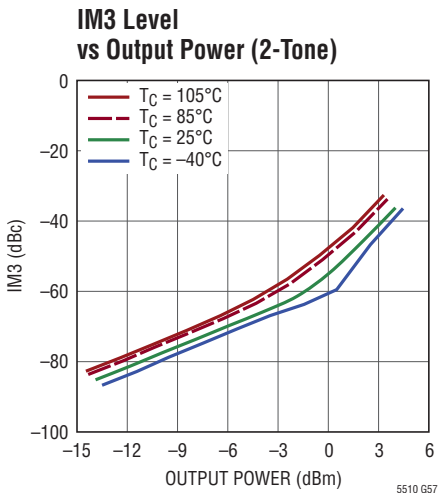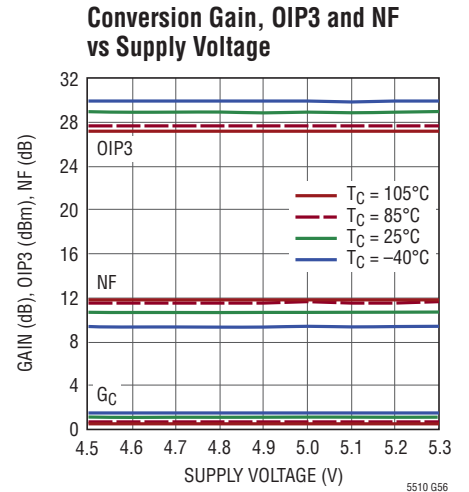### Conversion Gain, IIP3 and NF vs Input Frequency

5510 G60

Conversion Gain and IIP3 vs Output Frequency

5510 G61

LO Leakage vs LO Frequency

5510 G62

Conversion Gain, IIP3 and NF vs LO Power

5510 G63

Noise Figure vs Input Blocker Level

f_{IN} = 900MHz
f_{BLOCK} = 800MHz
f_{LO} = 944MHz

5510 G64

Conversion Gain, IIP3 and NF vs Supply Voltage

5510 G65

IM3 Level vs Input Power (2-Tone)

5510 G66

Conversion Gain, IIP3, NF and Input P1dB vs Case Temperature

5510 G68

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PIN FUNCTIONS

TEMP (Pin 1): Temperature Monitor. This pin is connected to the anode of a diode through a 30Ω resistor. It may be used to measure the die temperature by forcing a current into the pin and measuring the voltage.

IN+, IN− (Pins 2, 3): Differential Signal Input. For optimum performance, these pins should be driven with a differential signal. The input can be driven single-ended, with some performance degradation, by connecting the undriven pin to RF ground through a capacitor. An internally generated 1.6V DC bias voltage is present on these pins, thus DC blocking capacitors are required.

LGND (Pin 4): DC Ground Return for the Input Amplifier. This pin must be connected to DC ground. The typical current from this pin is 64mA. In some applications an external chip inductor may be used. Note that any inductor DC resistance will reduce the current through this pin.

EN (Pin 5): Enable Pin. When the applied voltage is greater than 1.8V, the IC is enabled. Below 0.5V, the IC is disabled.

V_{CC1}, V_{CC2} (Pins 6, 7): Power Supply Pins for the Bias and LO Buffer Circuits. Typical current consumption is 41mA. These pins should be connected together on the circuit board and decoupled with a 10nF capacitor located close to the pins.

I_{ADJ} (Pin 8): Bias Adjust Pin. This pin allows adjustment of the internal mixer current by adding an external pull-down resistor. The typical DC voltage on this pin is 1.8V. If not used, this pin must be left floating.

GND (Pins 9, 12, 13, Exposed Pad (Pin 17)): Ground. These pins must be soldered to the RF ground plane on the circuit board. The exposed metal pad of the package provides both electrical contact to ground and a good thermal contact to the printed circuit board.

OUT−, OUT+ (Pins 10, 11,): Differential Output. These pins must be connected to a DC supply through impedance matching inductors and/or a transformer center-tap. Typical DC current consumption is 32mA into each pin.

LO−, LO+ (Pins 14, 15): Differential Local Oscillator Input. A single-ended LO may be used by connecting one pin to RF ground through a DC blocking capacitor. These pins are internally biased to 1.7V; thus, DC blocking capacitors are required. Each LO input pin is internally matched to 50Ω for both EN states.

TP (Pin 16): Test Pin. This pin is used for production test purposes only and must be connected to ground.

BLOCK DIAGRAM

5510 BD

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TEST CIRCUITS

DC1983A
EVALUATION BOARD
STACK-UP
(NELCO N4000-13)
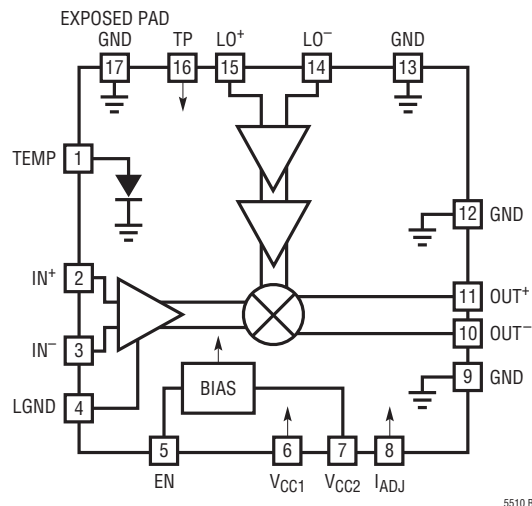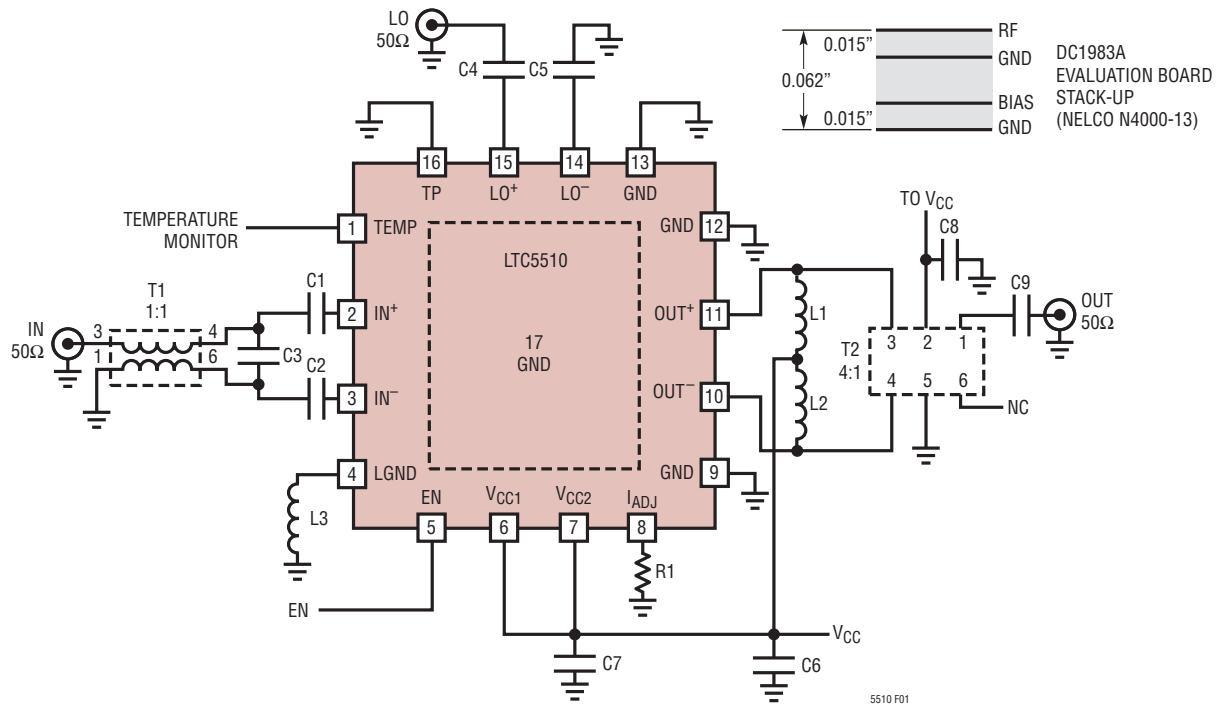
REF DES	5V/3.3V Wideband Up/Downmixer* f_{IN} = 30MHz-3000MHz f_{OUT} = 1575MHz	5V Wideband Upmixer f_{IN} = 30MHz-2500 MHz f_{OUT} = 2140MHz	SIZE	COMMENTS
C1, C2, C4, C5	0.1µF	0.1µF	0402	Murata GRM15, X7R
C3	0.7pF	-	0402	Murata GJM15, C0G
C6	1µF	1µF	0603	Murata GRM18, X7R
C7, C8	10nF	10nF	0402	Murata GRM15, X7R
C9	6.8pF	5.6pF	0402	Murata GJM15, C0G
L1, L2	6.8nH	5.6nH	0402	CoilCraft 0402HP
L3	0Ω	0Ω	0603	
R1	4.75kΩ (5V), 1.8kΩ (3.3V)	4.75kΩ	0402	1%
T1	Mini-Circuits TC1-1-13M+	Mini-Circuits TC1-1-13M+		
T2	Anaren BD1222J50200AHF	Mini-Circuits NCS4-232+		

*Standard DC1983A Eval Board Configuration

Figure 1. High Frequency Output Test Circuit Schematic (DC1983A)

TEST CIRCUITS

Figure 2. Low Frequency Output Test Circuit Schematic (DC1984A)
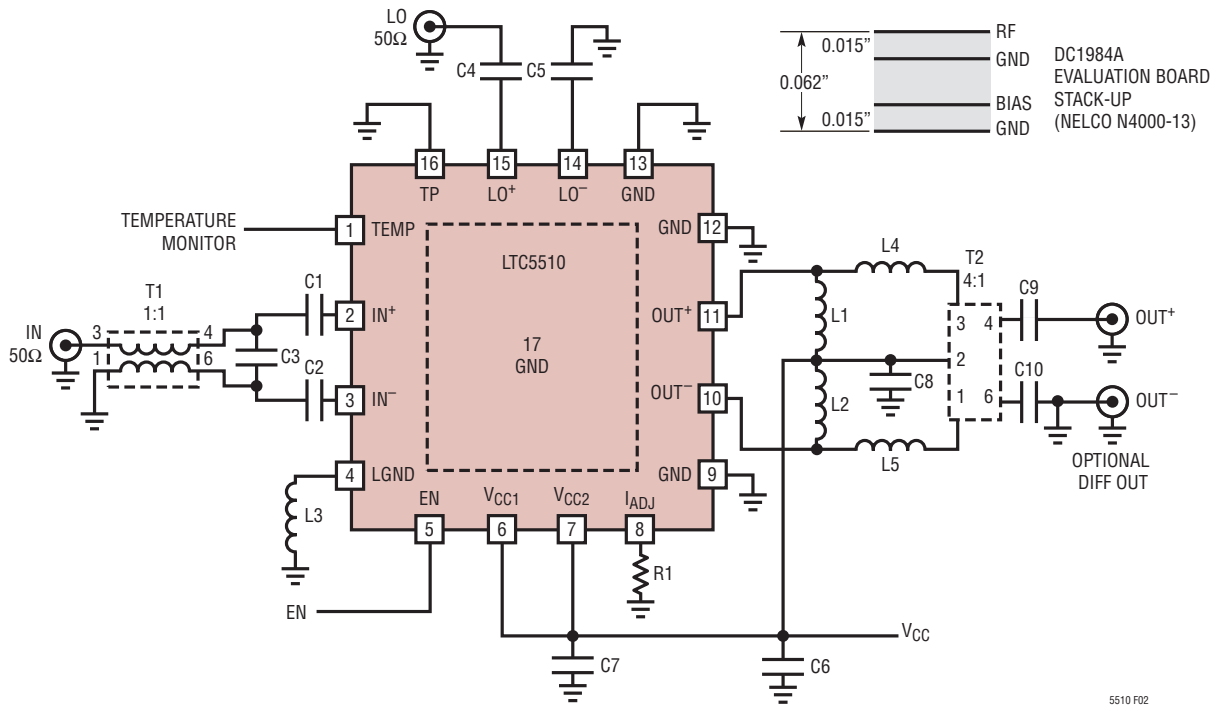
REF DES	5V VHF/UHF Upmixer* $f_{IN} = 70MHz$ $f_{OUT} = 100MHz-1000 MHz$	5V VHF/UHF Wideband Downmixer $f_{IN} = 100MHz-1000 MHz$ $f_{OUT} = 44MHz$	SIZE	COMMENTS
C1, C2, C4, C5	0.1µF	0.1µF	0402	Murata GRM15, X7R
C3	0.5pF	0.9pF	0402	Murata GJM15, C0G
C6	1µF	1µF	0603	Murata GRM18, X7R
C7, C8, C9, C10	10nF	10nF	0402	Murata GRM15, X7R
L1, L2	-	-	0603	
L3	220nH	0Ω	0603	Coilcraft 0603HP, WE 744761
L4, L5	15nH	0Ω	0402	CoilCraft 0402HP
R1	-	-	0402	
T1	Mini-Circuits TC1-1-13M+	Mini-Circuits TC1-1-13M+		
T2	Mini-Circuits TC4-19LN+	Mini-Circuits TC4-1W-7ALN+		

*Standard DC1984A Eval Board Configuration

APPLICATIONS INFORMATION

The LTC5510 uses wideband high performance RF and LO amplifiers driving a double-balanced mixer core to achieve frequency up- or down-conversion with high linearity over a very broad frequency range. For flexibility, all ports are differential; however, the LO port has also been optimized for single-ended use. Low side or high side LO injection can be used. The IN port may also be driven single-ended, though with some reduction in performance.

See the Pin Functions and Block Diagram sections for a description of each pin. Test circuit schematics showing all

3a. High Frequency Output Board (DC1983A)

3b. Low Frequency Output Board (DC1984A)

Figure 3. LTC5510 Evaluation Board Layouts

external components required for the data sheet specified performance are shown in Figures 1 and 2. The evaluation boards are shown in Figures 3a and 3b.

The High Frequency Output test circuit, shown in Figure 1, utilizes a multilayer chip balun to realize a single-ended output. The Low Frequency Output test circuit in Figure 2 uses a wire-wound balun and is designed to accommodate a differential output if desired. Both the IN and LO ports are very broadband and use the same configurations for both test circuits. Additional components may be used to modify the DC supply current or frequency response, which will be discussed in the following sections.

IN Port Interface

A simplified schematic of the mixer's input is shown in Figure 4a. The IN$^+$ and IN$^-$ pins drive the bases of the input transistors while internal resistors are used for impedance matching. These pins are internally biased to a common mode voltage of 1.6V, thus external capacitors C1 and C2 are required for DC isolation and can be used for impedance matching. A small value of C3 can be used to improve the impedance match at high frequencies and may improve noise figure. The 1:1 transformer, T1, provides single-ended to differential conversion for optimum performance.

The typical return loss at the IN port is shown in Figure 5 with 0.1µF at C1 and C2. The performance is better than 12dB up to 2.6GHz without C3. Adding a capacitance of 0.7pF at C3 extends the impedance match to 3GHz.

Differential input impedances (parallel equivalent) for various frequencies are listed in Table 1. At frequencies below 30MHz additional external components may be needed to optimize the input impedance. Figure 4b shows an equivalent circuit that can be used for single-ended or differential impedance matching at frequencies below 1GHz. Above 1GHz, the S-parameters should be used.

The DC bias current of the input amplifier flows through Pin 4 (LGND). Typically this pin should be directly connected to a good RF ground; however, at lower input frequencies it may be beneficial to insert an inductor to ground for improved IP2 performance. The inductor should have low resistance and must be rated to handle 64mA DC current.
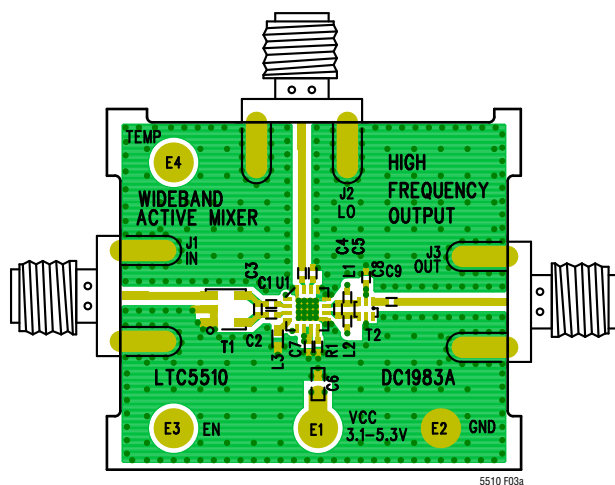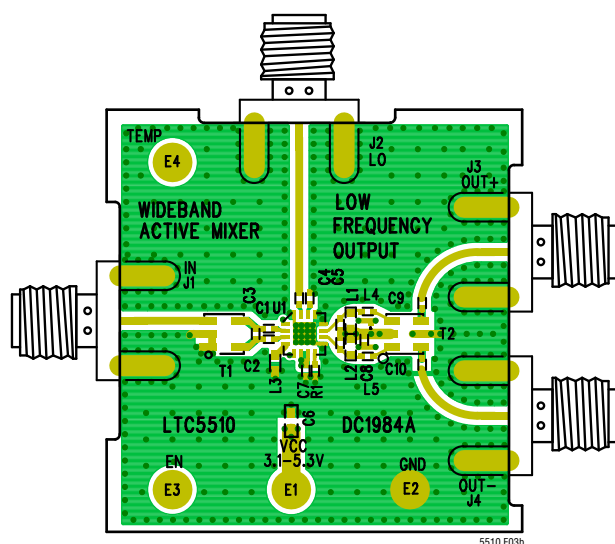
APPLICATIONS INFORMATION
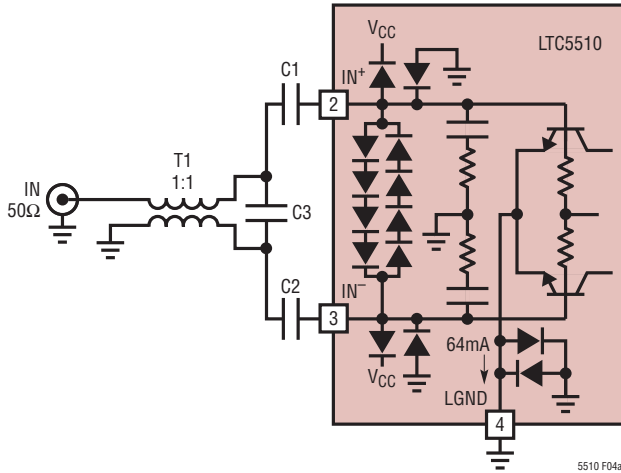
Figure 4a. IN Port with External Matching
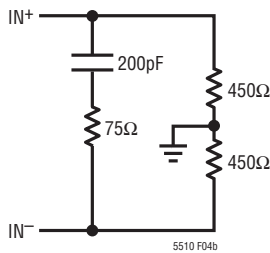
Figure 4b. IN Port Equivalent Circuit (< 1GHz)
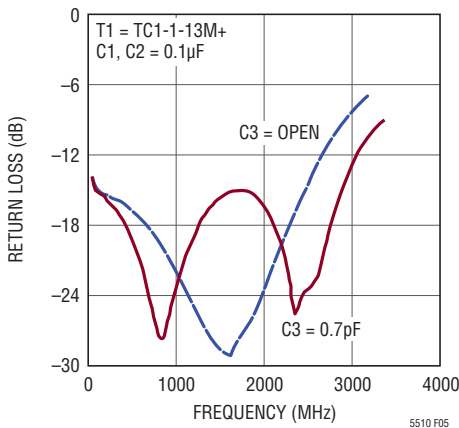
Figure 5. IN Port Return Loss

Table 1. IN Port Differential Impedance

FREQUENCY (MHz)	IMPEDANCE (Ω)		REFL. COEFF.	
	REAL*	IMAG*	MAG	ANG (°)
0.2	823	−j3971	0.89	−1.4
1	751	−j800	0.88	−7.2
10	133	−j154	0.50	−41
30	78.1	−j248	0.25	−36
50	73.3	−j378	0.20	−27
100	71.3	−j665	0.18	−17
200	70.7	−j961	0.17	−12
500	70.0	−j832	0.17	−14
1000	67.9	−j509	0.16	−24
1200	66.7	−j439	0.16	−28
1500	64.6	−j367	0.15	−35
2000	60.4	−j302	0.13	−49
2200	58.5	−j289	0.12	−55
2500	55.5	−j280	0.11	−66
3000	50.6	−j303	0.08	−91
4000	42.9	−j7460	0.08	−178
5000	42.7	j155	0.17	126
6000	55.9	j89	0.29	96

*Parallel Equivalent Impedance

LO Input Interface

The LTC5510 can be driven by a single-ended or differential LO signal. Internal resistors, as shown in Figure 6, provide an impedance match of 50Ω per side or 100Ω differential. The impedance match is maintained when the part is disabled as well. The LO input pins are internally biased to 1.7V, thus external capacitors, C4 and C5 are used to provide DC isolation.

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APPLICATIONS INFORMATION

The measured return loss of the LO input port is shown in Figure 7 for C4 and C5 values of 0.1µF. The return loss is better than 10dB from 5MHz to 6GHz. For frequencies below 5MHz, larger C4 and C5 values are required. Table 2 lists the single-ended input impedance and reflection coefficient versus frequency for the LO input. The differential impedance is listed in Table 3.
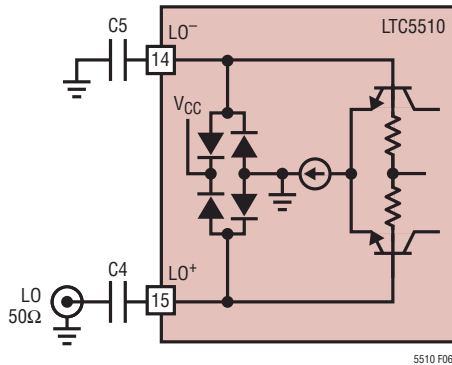
Figure 6. LO Input Circuit
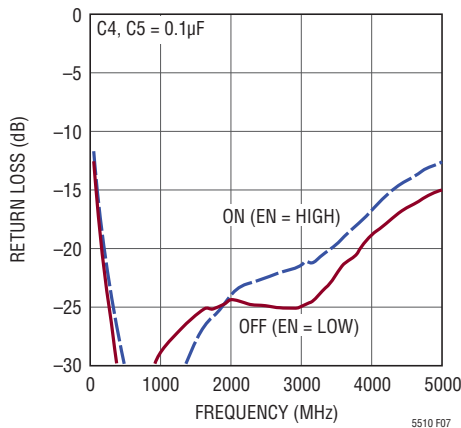
Figure 7. Single-Ended LO Input Return Loss

Table 2. Single-Ended LO Input Impedance

FREQUENCY (MHz)	IMPEDANCE (Ω)		REFL. COEFF.	
	REAL	IMAG	MAG	ANG (°)
1	90.3	−1.0	0.29	−1
10	87.5	−7.1	0.28	−8
100	55.3	−16.4	0.16	−63
600	47.8	−5.0	0.06	−111
1100	47.0	−4.7	0.06	−119
1600	46.2	−5.0	0.06	−124
2100	45.2	−5.1	0.07	−130
2600	44.2	−4.7	0.08	−138
3100	43.2	−3.9	0.08	−148
3600	42.3	−2.4	0.09	−161
4100	41.5	−0.3	0.09	−178
4500	40.8	2.0	0.10	166
5000	40.1	5.6	0.13	147
6000	38.6	14.3	0.20	120
6500	37.7	19.1	0.25	110

Table 3. Differential LO Input Impedance

FREQUENCY (MHz)	IMPEDANCE (Ω)		REFL. COEFF.	
	REAL	IMAG	MAG	ANG (°)
1	94.9	−0.1	0.31	−0.1
10	95.3	−0.5	0.31	−0.4
100	94.8	−2.3	0.31	−2
600	91.7	−12.5	0.31	−12
1100	85.6	−20.1	0.30	−21
1600	78.4	−24.2	0.29	−30
2100	71.5	−25.4	0.27	−38
2600	65.7	−24.3	0.24	−45
3100	61.3	−21.7	0.22	−51
3600	58.2	−17.9	0.18	−56
4100	56.2	−13.3	0.14	−58
4500	55.2	−9.1	0.10	−55
5000	54.6	−2.9	0.05	−31
6000	54.0	11.0	0.11	64
6500	53.7	18.5	0.18	69

APPLICATIONS INFORMATION

OUT Port Interface

The differential output interface is shown in Figure 8. The OUT$^+$ and OUT$^-$ pins are open collector outputs with internal load resistors that provide a 245Ω differential output resistance at low frequencies.

Figure 9 shows the equivalent circuit of the output and Table 4 lists differential impedances for various frequencies. The impedance values are listed in parallel equivalent form, with equivalent capacitances also shown. For optimum single-ended performance, the differential output signal must be combined through an external transformer or a discrete balun circuit. In applications where differential filters or amplifiers follow the mixer, it is possible to eliminate the transformer and drive these components differentially.
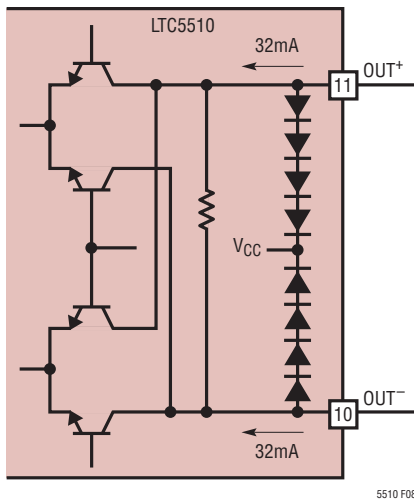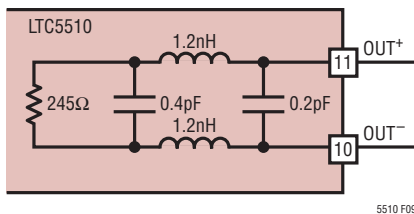

Figure 8. Output Interface

Figure 9. Output Port Equivalent Circuit

Output Matching: High Frequency Output Board

The high frequency (HF) output evaluation board (DC1983A) shown in Figure 3a is designed to use multilayer chip hybrid baluns at the output. This board is intended for frequencies above about 800MHz (limited by balun availability). These baluns deliver good performance and are smaller than wire-wound baluns. The board is configured for the matching topology shown in Figure 10. Inductors L1 and L2 are used to tune out the parasitic output capacitance, while the transformer provides differential to single-ended conversion and impedance transformation. The DC bias to the mixer core can be applied through the matching inductors. Each pin draws approximately 32mA of DC supply current.

Table 4. Differential OUT Port Impedance

FREQUENCY (MHz)	IMPEDANCE (Ω)		REFL. COEFF.	
	REAL*	IMAG* (CAP)	MAG	ANG
1	245	−j240k (0.67pF)	0.66	0.0
10	244	−j40k (0.40pF)	0.66	−0.2
50	244	−j5.31k (0.60pF)	0.66	−1.1
100	245	−j2.66k (0.60pF)	0.66	−2.3
300	243	−j884 (0.60pF)	0.66	−6.8
500	240	−j529 (0.60pF)	0.66	−11
1000	224	−j260 (0.61pF)	0.65	−23
1500	201	−j169 (0.63pF)	0.63	−35
2000	171	−j122 (0.65pF)	0.60	−48
2500	138	−j93 (0.69pF)	0.57	−62
3000	104	−j73 (0.73pF)	0.53	−78
3500	73	−j59 (0.77pF)	0.48	−97
4000	47	−j51 (0.78pF)	0.43	−120
4500	29	−j59 (0.60pF)	0.39	−148
5000	22	j4.74K	0.38	180
6000	49	j51	0.44	117

* Parallel Equivalent

APPLICATIONS INFORMATION

Capacitor C9 can be used to improve the impedance match. The component values used for characterization are listed in Table 5, along with the 12dB return loss bandwidths. The measured return loss curves are plotted in Figure 11.
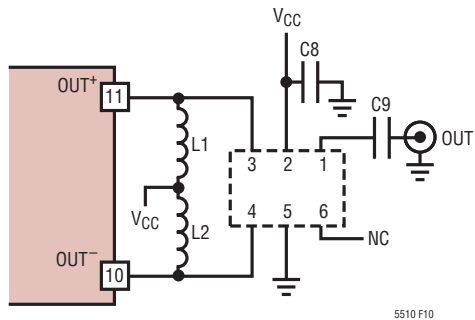

Figure 10. HF Board Output Schematic

Table 5. OUT Port Component Values: HF Output Board (DC1983A)

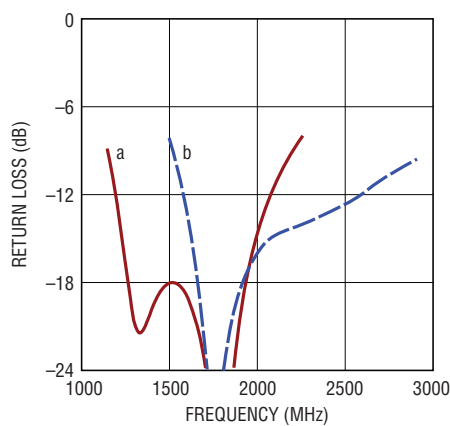| FREQUENCY (MHz)	RANGE* (GHz)	L1, L2 (nH)	C9 (pF)	T2
1575	1.2 to 2.1	6.8	6.8	Anaren BD1222J50200AHF
2140	1.6 to 2.5	5.6	5.6	Mini-Circuits NCS4-232+

* 12dB Return Loss Bandwidth

Figure 11. Out Port Return Loss of HF Board (DC1983A). Tuned for 1575MHz (a), and 2140MHz (b)

Output Matching: Low Frequency Output Board

For lower output frequencies, wire-wound transformers provide better performance. The low frequency (LF) evaluation board (DC1984A) in Figure 3(b) accommodates these applications. The output matching topology is shown in Figure 12. Components L1, L2, L4 and L5 are used to tune the impedance match, while T2 provides the desired impedance transformation. C9 and C10 are used for DC blocking in some applications. Table 6 lists component values used for characterization, and the measured return loss performance is plotted in Figure 13.
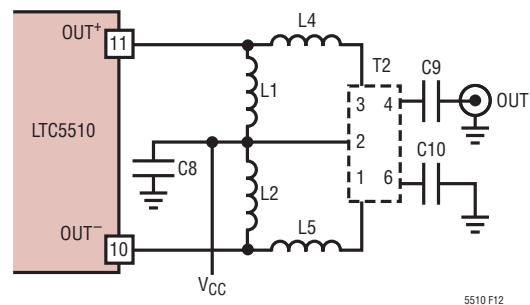

Figure 12. LF Board Output Schematic

Table 6. OUT Port Component Values: LF Output Board (DC1984A)

FREQUENCY (MHz)	RANGE* (MHz)	L1, L2 (nH)	L4, L5 (nH)	T2
44	5 to 325	–	0Ω	Mini-Circuits TC4-1W-7ALN+
456	10 to 1300	–	15	Mini-Circuits TC4-19LN+

* 12dB Return Loss Bandwidth
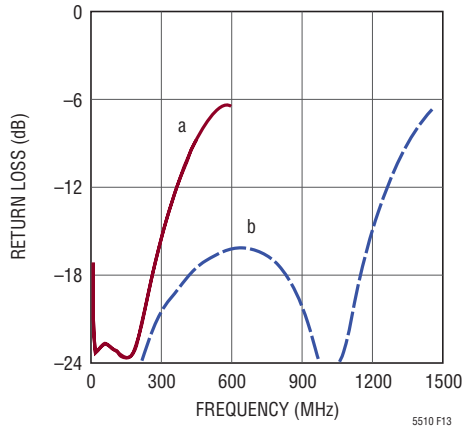
APPLICATIONS INFORMATION

Figure 13. Out Port Return Loss of LF Board (DC1984A) Tuned for 44MHz (a), and 456MHz (b)

DC and RF Grounding

The LTC5510 relies on the backside ground for both RF and thermal performance. The exposed pad must be soldered to the low impedance top side ground plane of the board. The top side ground should also be connected to other ground layers to aid in thermal dissipation and ensure a low inductance RF ground. The LTC5510 evaluation boards (Figures 3a and 3b) utilize a 4×4 array of vias under the exposed pad for this purpose.

Enable Interface

Figure 14 shows a schematic of the EN pin interface. To enable the part, the applied EN voltage must be greater than 1.8V. Setting the voltage below 0.5V will disable the IC. If the enable function is not required, the enable pin can be connected to V_{CC} through a 1k resistor. The ramp-up time of the supply voltage should be greater than 1ms. The voltage at the enable pin should never exceed the power supply voltage (V_{CC}) by more than 0.3V. Under no circumstances should voltage be applied to the enable pin before the supply voltage is applied to the V_{CC} pin. If this occurs, damage to the IC may result.
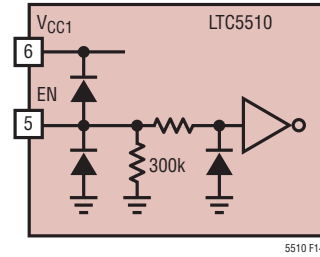

Figure 14. Enable Pin Interface

Current Adjust Pin (I_{ADJ})

The I_{ADJ} pin (Pin 8) can be used to optimize the performance of the mixer core over temperature. The nominal open-circuit DC voltage on this pin is 1.8V and the typical short-circuit current is 1.9mA. As shown in Figure 15, an internal 4mA reference sets the current in the mixer core. Connecting resistor R1 to the I_{ADJ} pin shunts some of the reference current to ground, thus reducing the mixer core current. The optimum value of R1 depends on the supply voltage and intended output frequency. Some recommended values are shown in Table 7, but the values can be optimized as required for individual applications.

Table 7. Recommended Values for R1

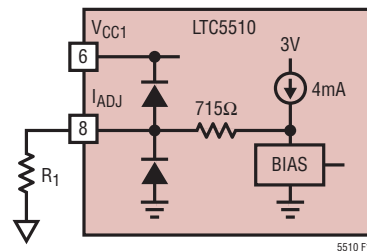| V_{CC} (V)	f_{OUT} (MHz)	R1 (Ω)	I_{CC} (mA)
5	<1200	Open	105
5	>1200	4.75k	99
3.3	<1200	1k	90
3.3	>1200	1.8k	94

Figure 15. Current Adjust Pin Interface

APPLICATIONS INFORMATION

Temperature Monitor (TEMP)

The TEMP input (pin 1) is connected to an on-chip diode that can be used as a coarse temperature monitor by forcing current into it and measuring the resulting voltage. The temperature diode is protected by a series 30Ω resistor and additional ESD diodes to ground.

The TEMP pin voltage is shown as a function of junction temperature in Figure 16. Given the voltage (in mV) at the pin, V_D, the junction temperature can be estimated for forced input currents of 10µA and 80µA using the following equations:

$$T_J (10µA) = (V_D - 742.4)/ -1.796$$

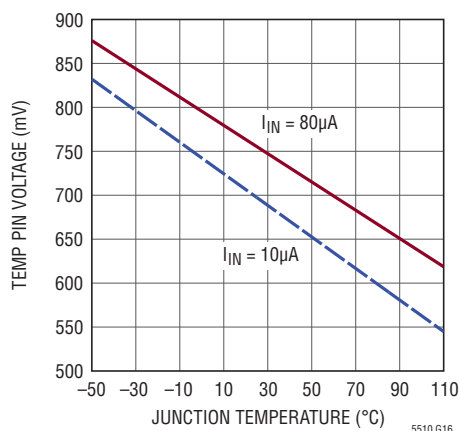$$T_J (80µA) = (V_D - 795.6)/ -1.609$$

Figure 16. TEMP Pin Voltage vs Junction Temperature

Auto Supply Voltage Detect

An internal circuit automatically detects the supply voltage and configures internal components for 3.3V or 5V operation. The DC current is affected when the auto-detect circuit switches at approximately 4.1V. To avoid undesired operation, the mixer should only be operated in the 3.1V to 3.6V or 4.5V to 5.3V supply ranges.

Supply Voltage Ramping

Fast ramping of the supply voltage can cause a current glitch in the internal ESD protection circuits. Depending on the supply inductance, this could result in a supply voltage transient that exceeds the maximum rating. A supply voltage ramp time of greater than 1ms is recommended.

The ramp rate of the supply voltage at the V_{CC} pins should not exceed 20V/ms. If the EN and V_{CC} pins are switched simultaneously, the configuration in Figure 17 can be used to slow the rise time at the V_{CC} pins if needed.
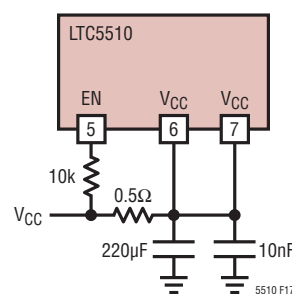

Figure 17. Suggested Configuration for Simultaneous V_{CC} and EN Switching

Spurious Output Levels

Mixer spurious output levels versus harmonics of the IN and LO frequencies are tabulated in Tables 8 and 9 for the 5V Wideband Up/Downmixer application. Results are shown for frequencies up to 15GHz. The spur frequencies can be calculated using the following equation:

$$f_{SPUR} = |M \bullet f_{IN} \pm N \bullet f_{LO}|$$

Table 8 shows the "difference" spurs ($f_{SPUR} = |M \bullet f_{IN} - N \bullet f_{LO}|$) and Table 9 shows the "sum" spurs ($f_{SPUR} = M \bullet f_{IN} + N \bullet f_{LO}$). The spur levels were measured on a standard evaluation board at room temperature using the test circuit shown in Figure 1. The spurious output levels for each application will be dependent on the external matching circuits and the particular application frequencies.

APPLICATIONS INFORMATION

Table 8. Output Spur Levels (dBc), $f_{SPUR} = |M \cdot f_{IN} - N \cdot f_{LO}|$ (f_{IN} = 190MHz at –7dBm, f_{LO} = 1765MHz at 0dBm, V_{CC} = 5V)

		N								
		0	1	2	3	4	5	6	7	8
	0	–	–30	–30	–40	–18	–44	–4	–46	–24
	1	–64	0**	–50	–30	–64	–22	–55	–47	–72
	2	*	–37	–73	–65	–65	–58	–49	–72	–59
	3	*	–48	*	–71	*	–66	–79	–75	–86
	4	*	–68	*	–83	*	–84	*	*	*
M	5	*	–77	*	–84	*	–87	*	*	*
	6	*	–89	*	–87	*	*	*	*	*
	7	*	*	*	–86	*	*	*	*	*
	8	*	*	*	–84	*	*	*	*	*
	9	*	*	*	*	*	*	*	*	*
	10	*	*	*	*	*	*	*	*	*

* Less Than <–90dBc

**Carrier Frequency

Table 9. Output Spur Levels (dBc), $f_{SPUR} = M \cdot f_{IN} + N \cdot f_{LO}$ (f_{IN} = 190MHz at –7dBm, f_{LO} = 1765MHz at 0dBm, V_{CC} = 5V)

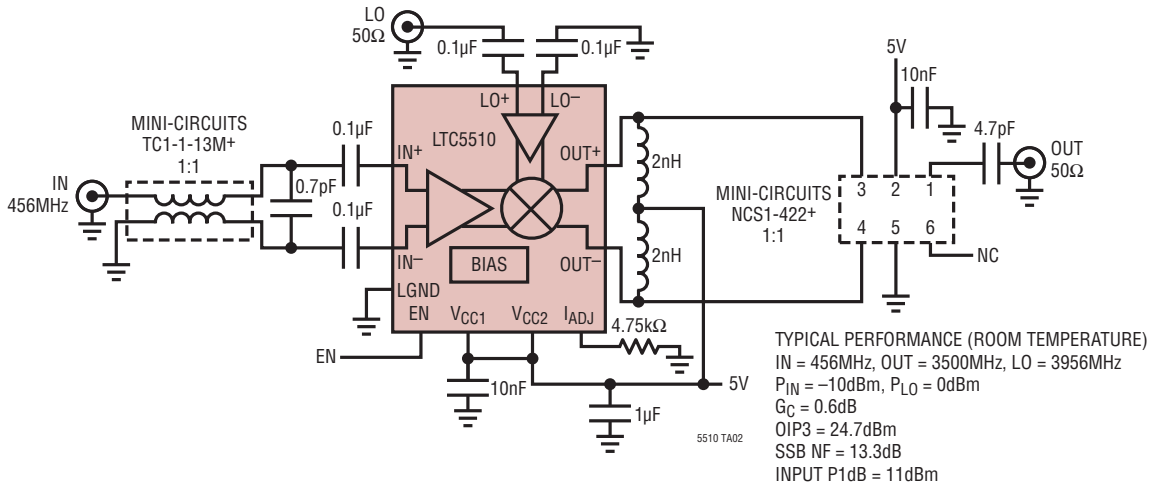|		N								
		0	1	2	3	4	5	6	7	8
	0	–	–30	–30	–40	–18	–44	–4	–46	–24
	1	-64	–0.4**	–50	–16	–55	–26	–52	–52	–69
	2	*	–36	–73	–50	–63	–59	–46	–76	–62
	3	*	–49	–88	–65	*	–72	–74	–84	–81
	4	*	–66	*	–84	–90	*	–79	*	*
M	5	*	–70	*	*	*	*	*	*	
	6	*	–73	*	*	*	*	*	*	
	7	*	–75	*	*	*	*	*	*	
	8	*	–74	*	*	*	*	*	*	
	9	*	–80	*	*	*	*	*	*	
	10	*	*	*	*	*	*	*	*	

* Less Than <–90dBc

**Image Frequency

5510fa

TYPICAL APPLICATIONS

Upmixer with 3.3GHz to 3.8GHz Output

MINI-CIRCUITS
TC1-1-13M+
1:1

IN
456MHz

0.7pF

0.1µF

0.1µF

LO
50Ω

0.1µF   0.1µF

LTC5510

LO+   LO−

IN+   OUT+

IN−   OUT−

BIAS

LGND

EN   V_CC1   V_CC2   I_ADJ

EN

10nF

1µF

4.75kΩ

5V

2nH

2nH

MINI-CIRCUITS
NCS1-422+
1:1

3   2   1

4   5   6

NC

5V

10nF

4.7pF

OUT
50Ω

TYPICAL PERFORMANCE (ROOM TEMPERATURE)
IN = 456MHz, OUT = 3500MHz, LO = 3956MHz
P_{IN} = −10dBm, P_{LO} = 0dBm
G_C = 0.6dB
OIP3 = 24.7dBm
SSB NF = 13.3dB
INPUT P1dB = 11dBm

5510 TA02

**Conversion Gain, OIP3 and NF
vs Output Frequency**

OIP3

NF

LSLO
HSLO

f_{IN} = 456MHz

G_C

5510 TA03

**Conversion Gain and OIP3
vs Input Frequency**

OIP3

LSLO
HSLO

f_{OUT} = 3500MHz

G_C

5510 TA04
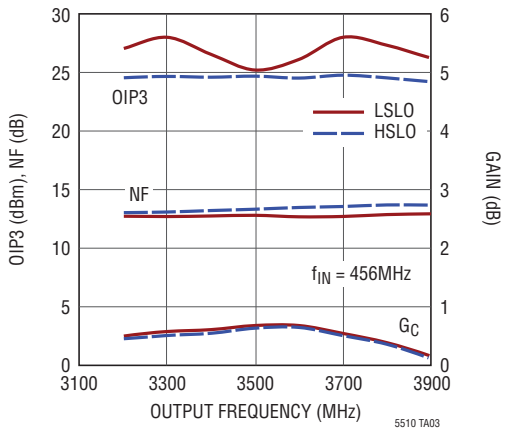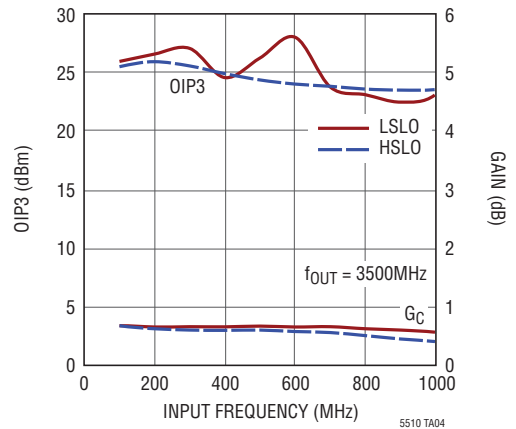
**IN Isolation and LO Leakage
vs Frequency**

IN-LO

IN-OUT

LO-OUT

LO-IN

5510 TA05
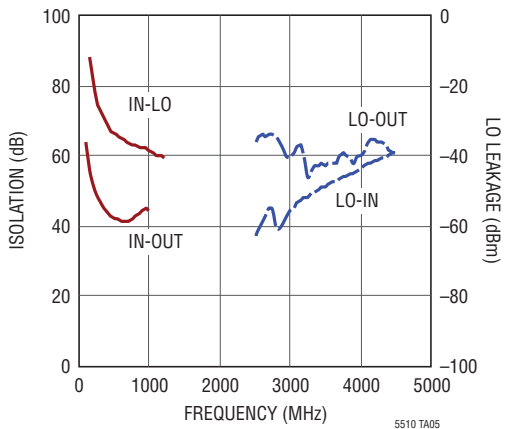
**IN, OUT and LO Port Return Loss
vs Frequency**

OUT

IN

LO

5510 TA06

5510fa